

Detector Summary

Taikan Suehara
(Kyushu University)

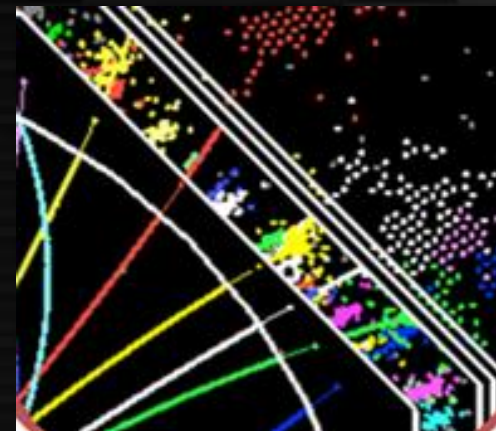
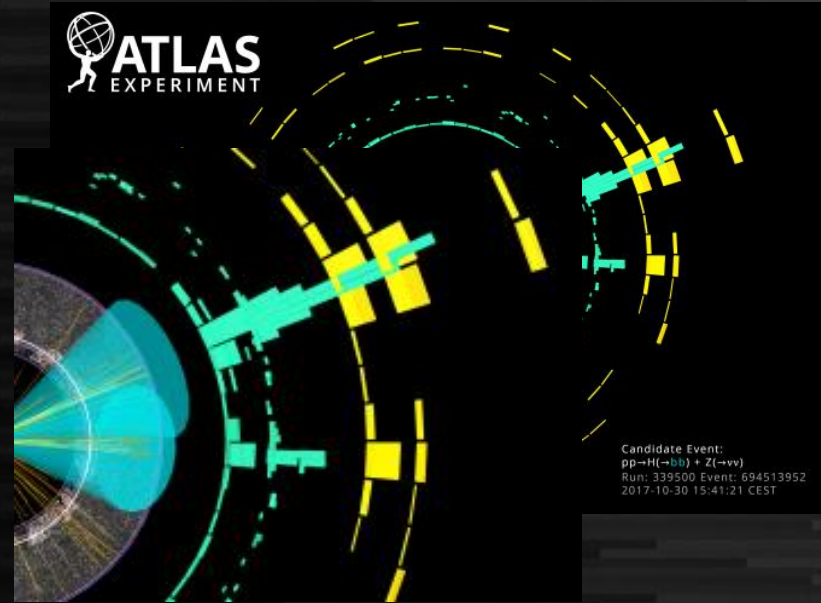


Activities in Detector sessions

- Vertex
 - 3 talks
(MIMOSA, DEPFET, HV-CMOS)
- Silicon tracking
 - 3 talks
(SiD sensor, CMS, FTD)
- TPC and dE/dx
 - 3 talks
(dE/dx, discharge, Timepix)
- Forward
 - 1 talk (LumiCAL/baemCAL)
- ECAL
 - 6 talks
- HCAL
 - 3 talks
- Muon
 - 3 talks
- MDI
 - 2 talks

DISCLAIMER
Impossible to cover
all the topics.

PFA detector: like HR camera



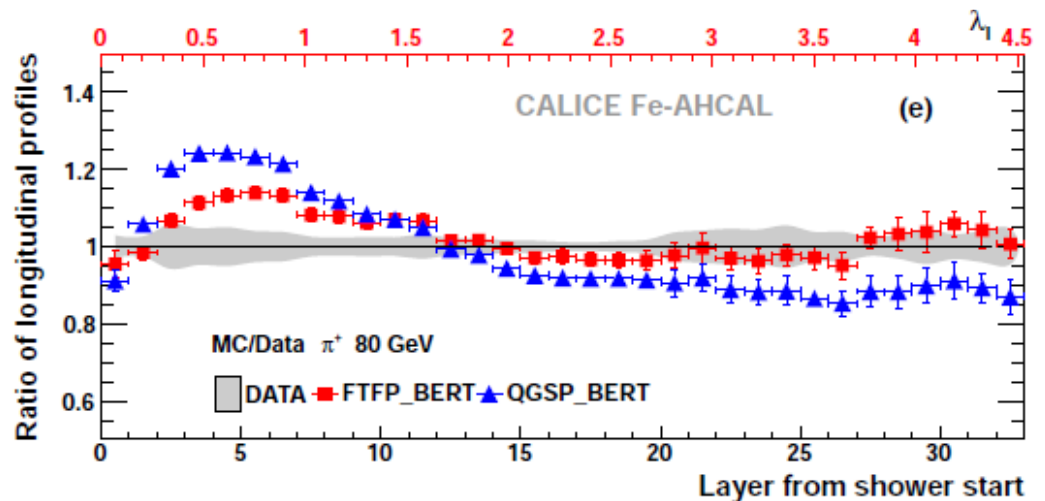
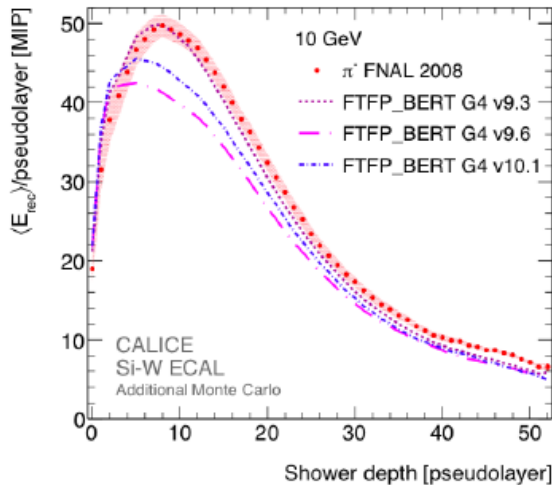
PFA detector: like HR camera



PFA is not only for improving jet energy resolution but we can get “additional dimension” of the events to unveil the nature of the terascale physics!

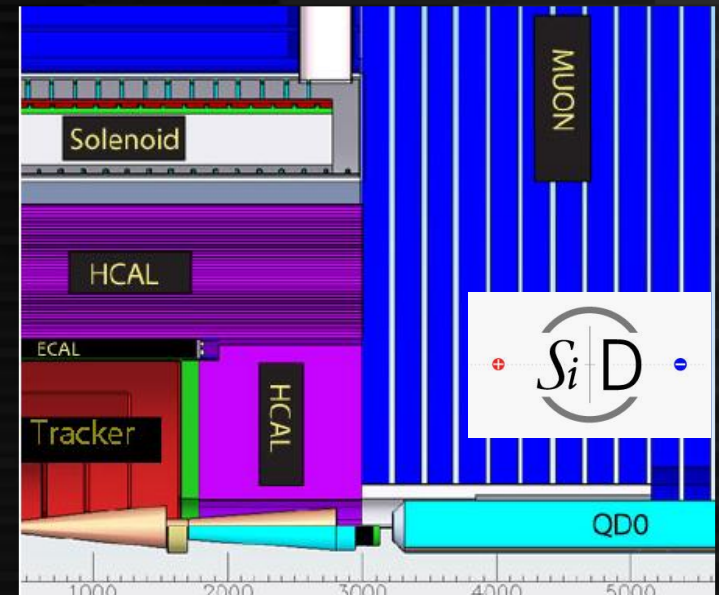
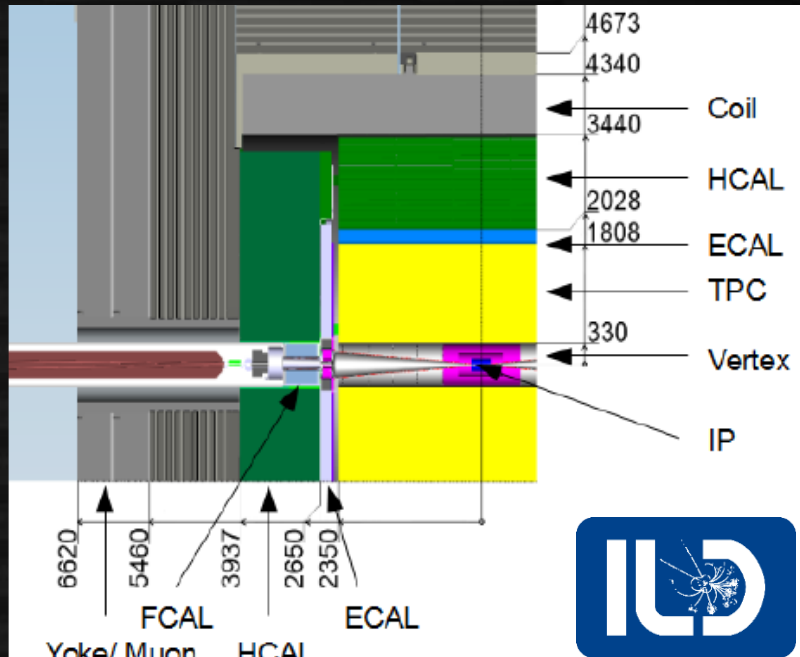
pp→H(→bb)+Z(→vv)
Run: 339500 Event: 694513952
2017-10-30 15:41:21 CEST

One example: CALICE sees deviation of shower profile from MC



Ingredients of PFA detectors

- Vertex detector
- Tracking (barrel / forward)
 - Silicon
 - TPC
- Very Forward
- ECAL
- HCAL
- Muon



Vertex detectors

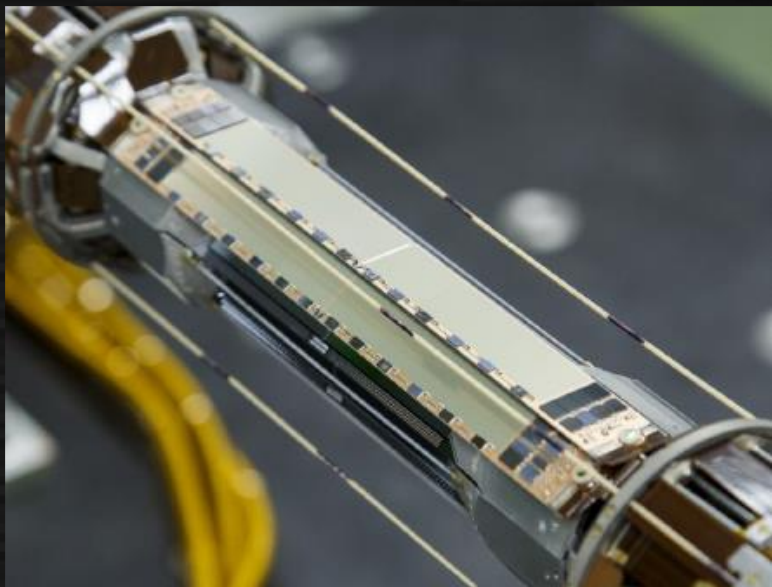
$\sigma_x \sim 3 \mu\text{m}$
Material $\sim 0.2 \% X_0 / \text{layer}$

Evolving CPS

	ULTIMATE STAR-PXL	ALPIDE ALICE-ITS	MIMOSA CBM-MVD	PSIRA proposal ILD-VXD
Data taking	2014-2016	>2021-2022	>2021	>2030
Technology	AMS-opto 0.35 μm	0.18 μm	0.18 μm	0.18 μm (conservative) < 0.18 μm ?
	4M	HR, $V_{\text{bias}} \sim -6\text{V}$ Deep P-well	HR, Deep P-well	?
Architecture	Rolling shutter + sparsification + binary output	Asynchronous r.o. In pixel discri.	Asynchronous r.o. In pixel discri.	Asynchronous r.o. (conservative)
Pitch (μm^2) / Sp. Res.	20.7 x 20.7 / 3.7	27 x 29 / 5	22 x 33 / <5	$\sim 22 / \sim 4$
Time resolution (μs)	~ 185	5-10	5	1-4

CMOS detector of MIMOSA technology

Other technologies FPCCD, SOI, Chronopix, ... exist as advanced options

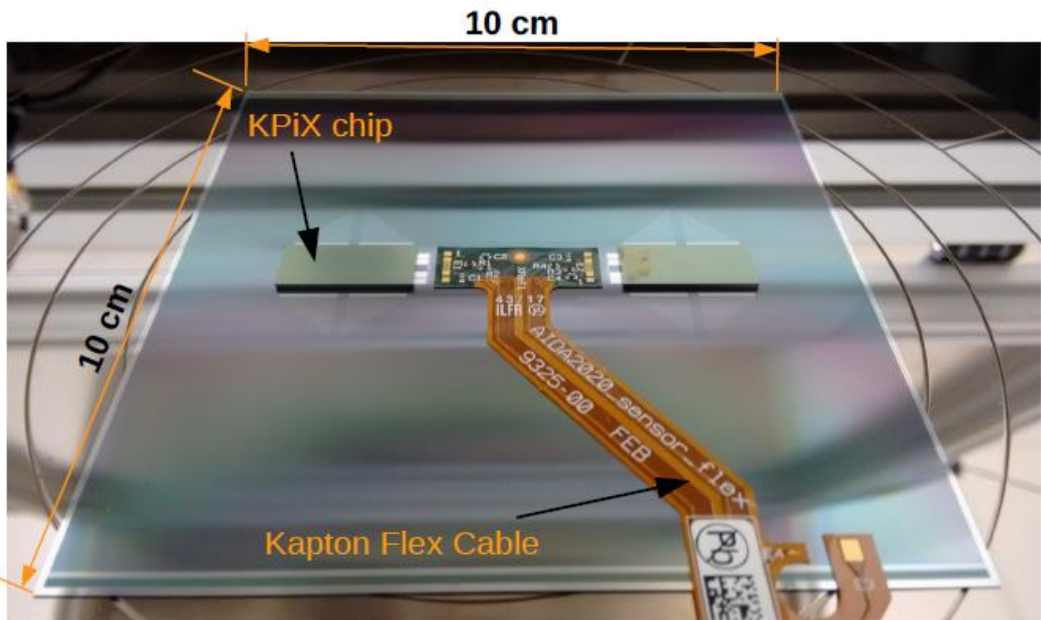


The monolithic sensors based on existing experiments are mature enough to extrapolate to ILC as “conservative baseline”

The first DEP-FET layer installed at Belle2

Silicon tracking

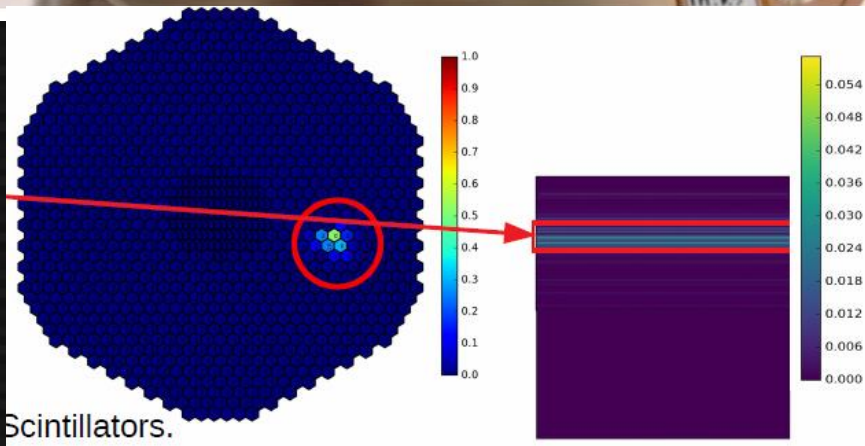
$\sigma_R \sim 7-10 \mu\text{m}$
 Material $\sim 0.5 \% X_0 / \text{layer}$



First SiD silicon tracker was fabricated with two KPIX ASICs (1024 ch each)

Preparing to be used for AIDA telescope in DESY

Technology of strip mature good for baseline, starting realistic prototyping



Concurrent event with tracker + ECAL seen

Expected Performances

- $\sigma_{sp} \sim 4 \mu\text{m} \Rightarrow$ Use double sided $\Rightarrow \sigma_{sp} \sim 2.8 \mu\text{m}$
 - $22 \times 22 \mu\text{m}^2 \sim 20\%$ better spatial resolution % ALPIDE ()
 - Faster = higher Power consumption
- Read-out time: 2-4 μs (ILD-VXD) and 1 μs (ILD-SIT)

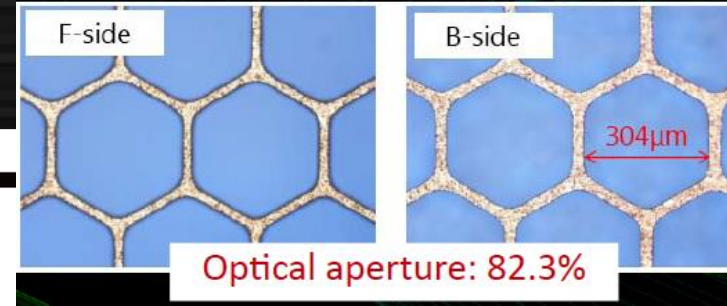
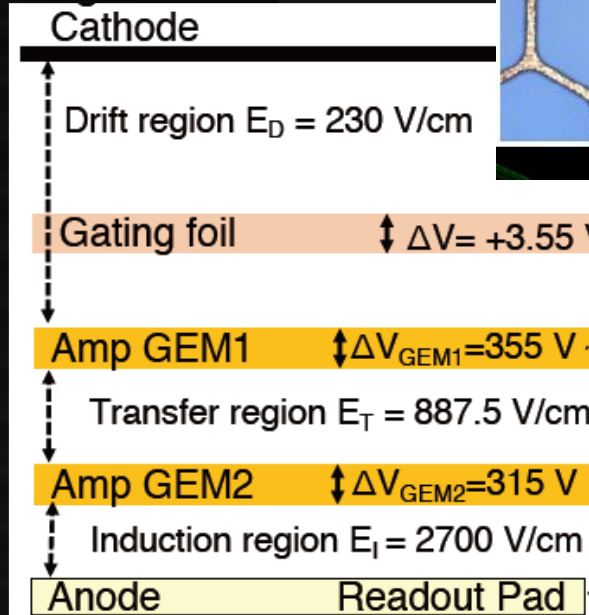
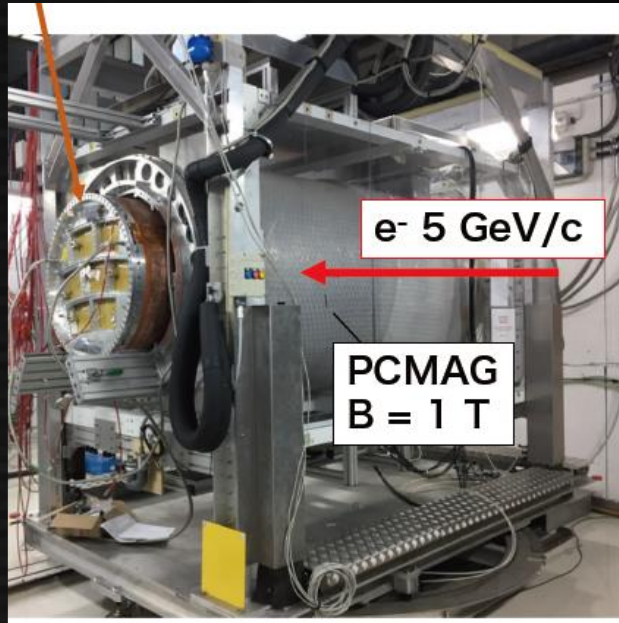
	kPIXM-Trk	kPIXM-Cal
Pixel size	50 x 200 μm^2	1000x1000 μm^2
Array	200 x 2400	100 x 94
Full size	stitched 5 x 5 reticles	
Max. signal	1 fC	1pC
Effective ENC	< 200 e^-	< 1000 e^-
S / N	> 20	> 4
in-pixel memory	1 bucket	16 buckets
ADC resolution	12 bits	
DC power consumption	$\sim 20 \mu\text{W} / \text{pixel}$	
power pulsing	yes	

MAPS Pixel option being considered in both ILD & SiD

Time Projection Chamber

$\sigma \sim 60 \mu\text{m}$, ~ 200 hits
Material \sim a few % X_0

Prototype TPC

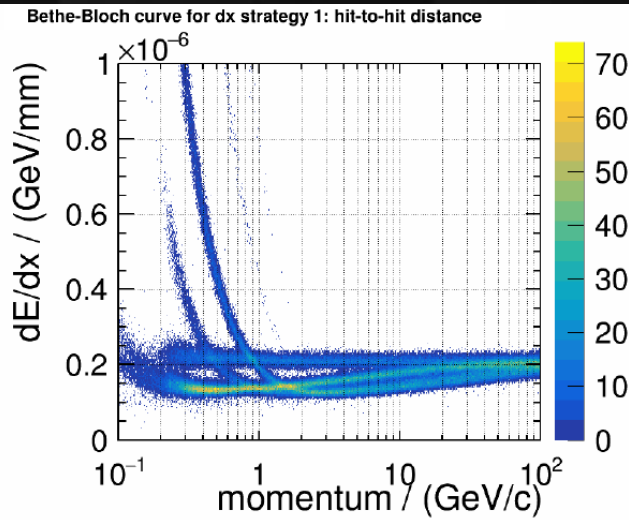


Gating foil for avoiding ion going back to TPC

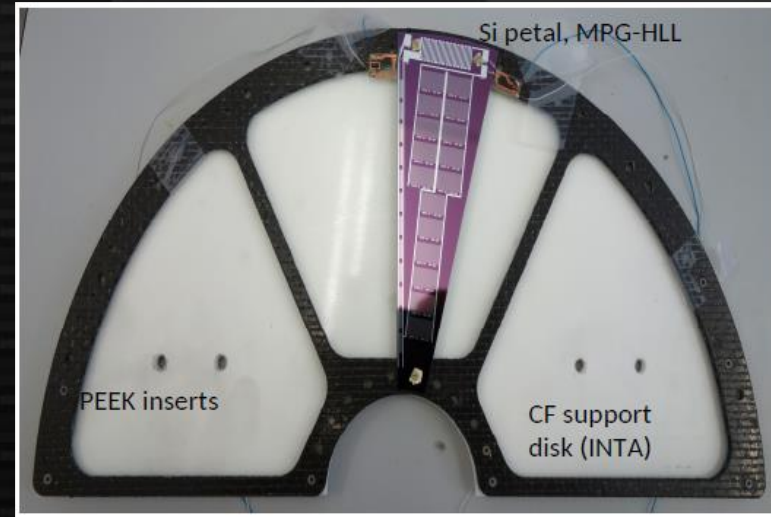
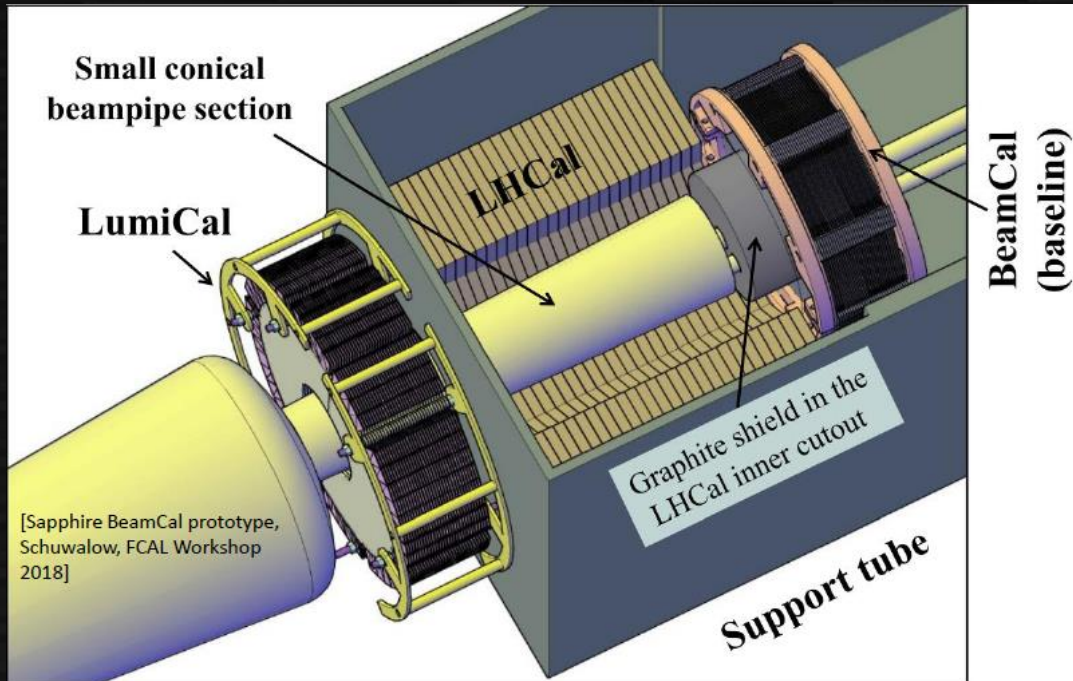
High optical aperture realized by cooperation with industry

Frequent test beam at DESY with 70 cm TPC: hardware mature enough

TPC enables the unique dE/dx measurement for particle ID



Forward devices



FTD mock-up



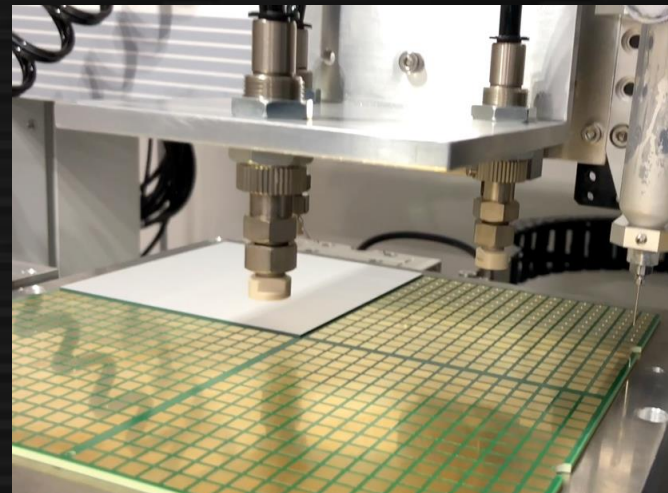
LumiCAL structure

Detector technology common to tracker/calorimeter
Mechanical design and prototyping ongoing

ECAL



Silicon pad for ILD ECAL

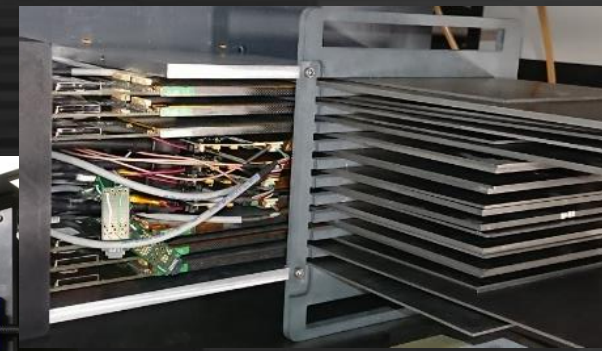


Assembly now possible both in France and Japan



“Long slab”

Intensive study ongoing mainly on electronics of large scale
Sensor and readout concept mature enough



Testing new slabs in CERN SPS



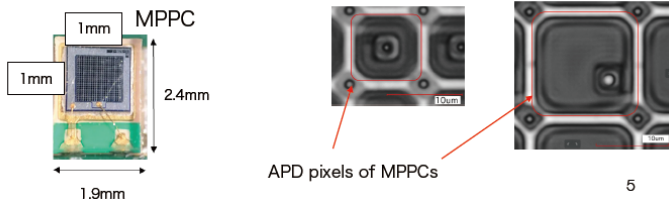
Chip-on-board electronics

Long-life needed: reliability is crucial

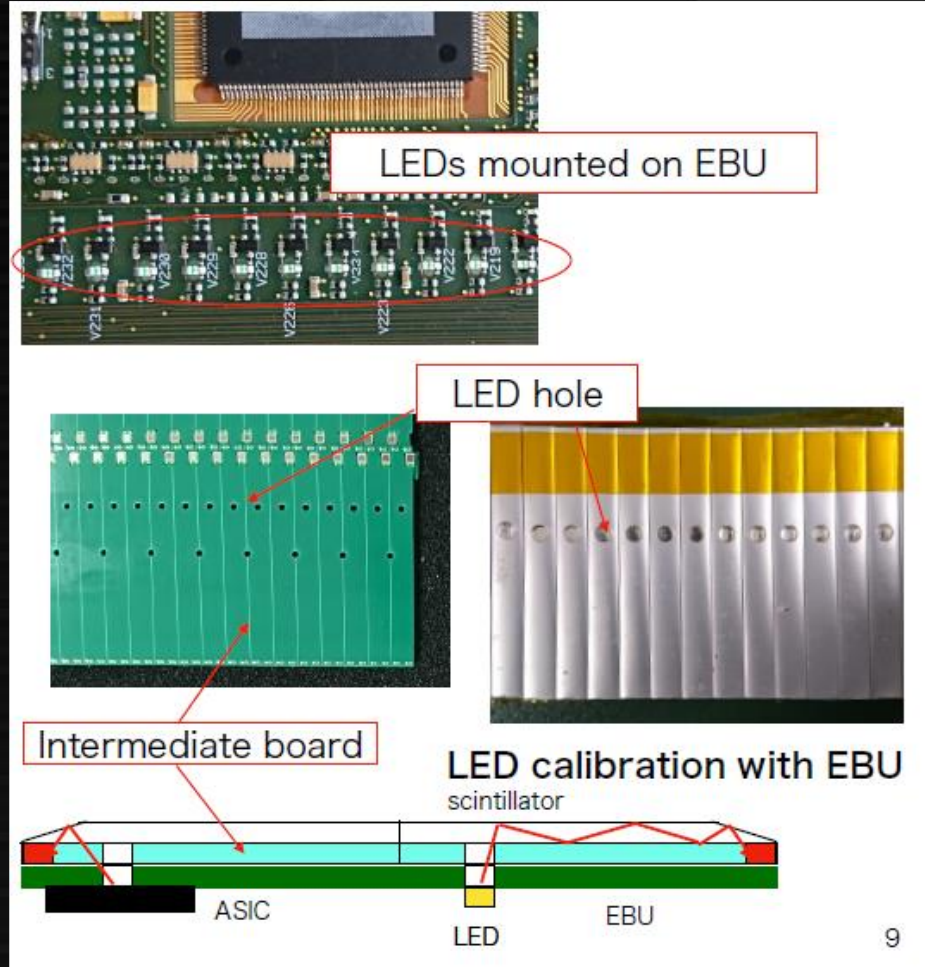
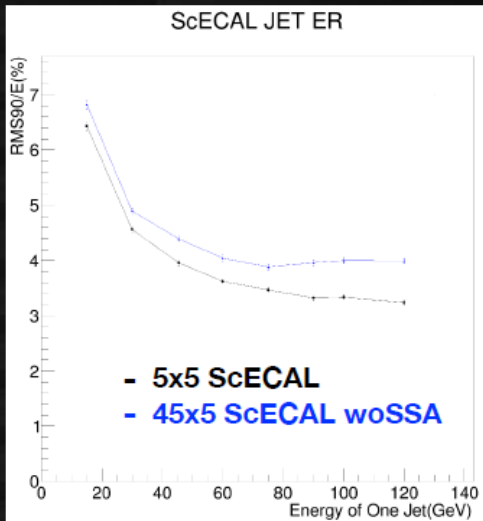
ECAL (cont.)

Hamamatsu catalog

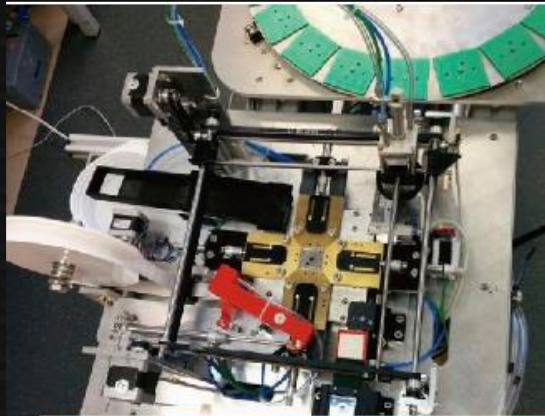
Model Number	S12571-010P	S12571-015P
Photosensitive area	1mm ²	1mm ²
Pixel size	10μm	15μm
Number of pixels	10000	4489
PDE	10%	25%
Gain	1.35x10 ⁵	2.3x10 ⁵
Geometrical fill factor	33%	53%



New 15 μm MPPC



HCAL



reflector wrapping machine



Pick & place machine



Big stack in test beams

Automatic assembly system developed



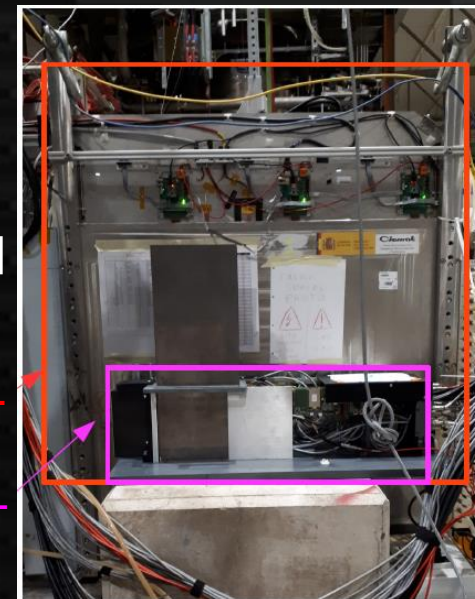
6 x 6 cm "Tokyo" module

Large technological prototype made and tested by beam
Technical feasibility well demonstrated

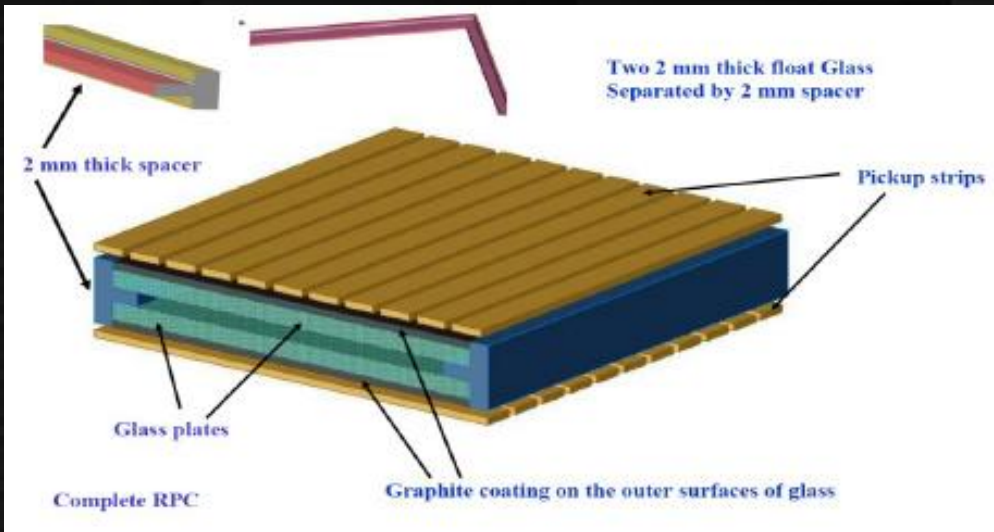
Combined testbeam

SDHCAL

SiW-ECAL



Muon



CEPC design of RPC muon

Though hardware activity of muon detectors is not high, Detector technology is common to calorimeter → no technical show-stoppers

ILC muon options

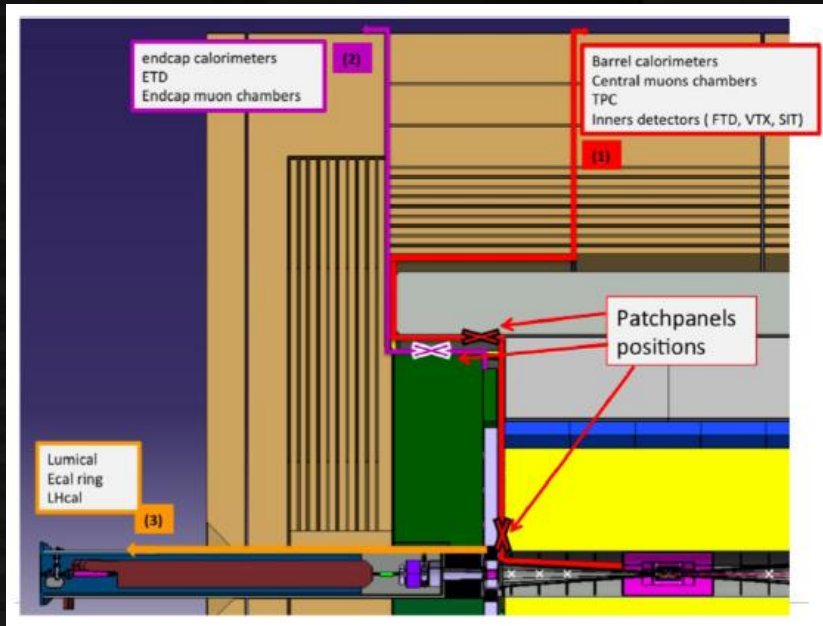
- Scintillator
- RPC
→ HCAL technology

- Drift Tubes (DT) in the Muon Barrel (MB)
- Cathode Strip Chambers (CSC) in the Muon Endcap (ME)
- Resistive Plate Chambers (RPC) throughout
- Muon Alignment derived for DT and CSC

CMS muon detectors: important for momentum of TeV muons → strip detectors

for ILC little advantage of strips

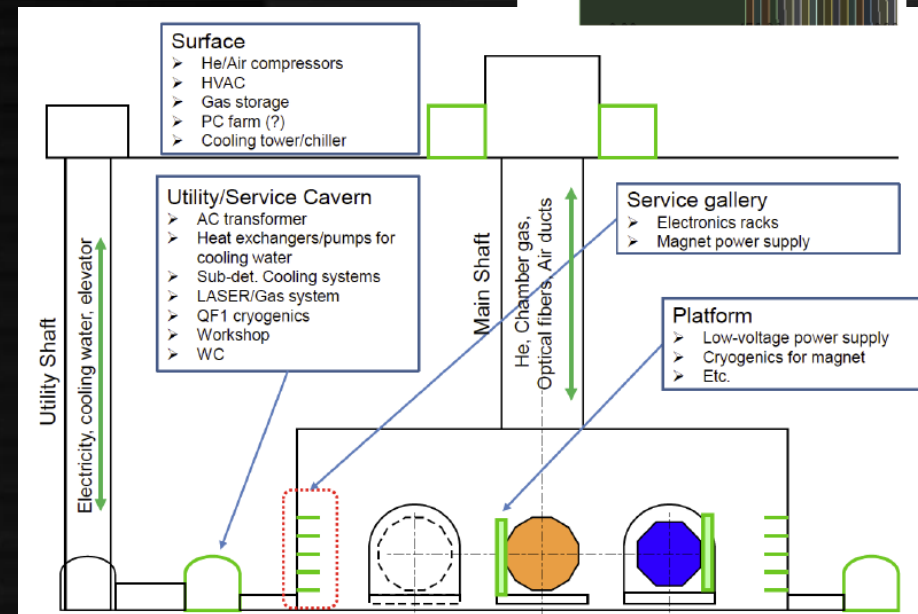
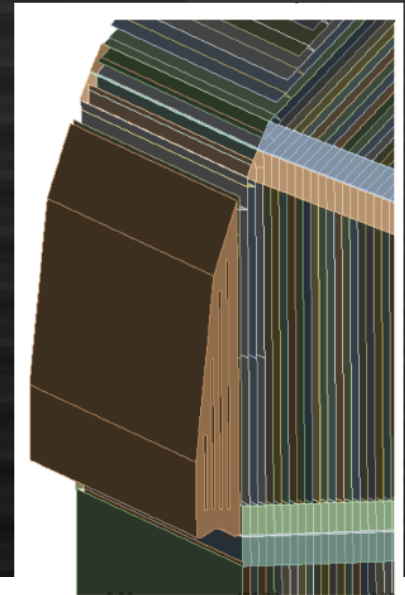
Integration



ILD cabling plan

Discussion on power, cabling, etc. has started towards realistic detector

Support structure of HCal

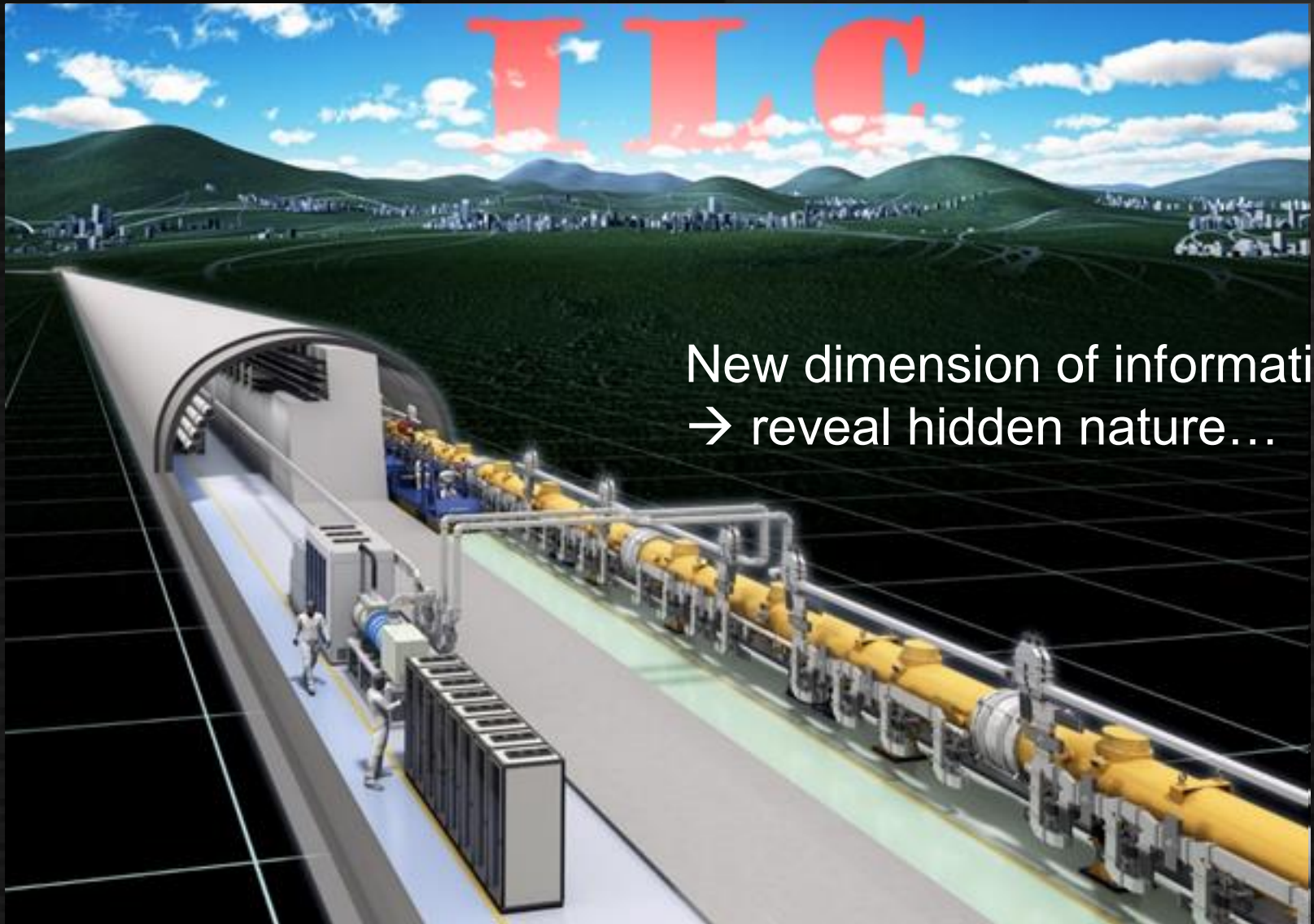


Consideration on space/power

Our PFA detector is ready!

- Active developments on core detectors
 - Vertex, Silicon tracker, TPC, ECAL, HCAL
- Baseline technologies are mature enough
 - Technological prototype already built or extrapolation from existing experiments expected
 - Powerful alternatives exist on some components
- No technical show-stoppers appeared
- Ready to start construction-ready design just after the “green light”

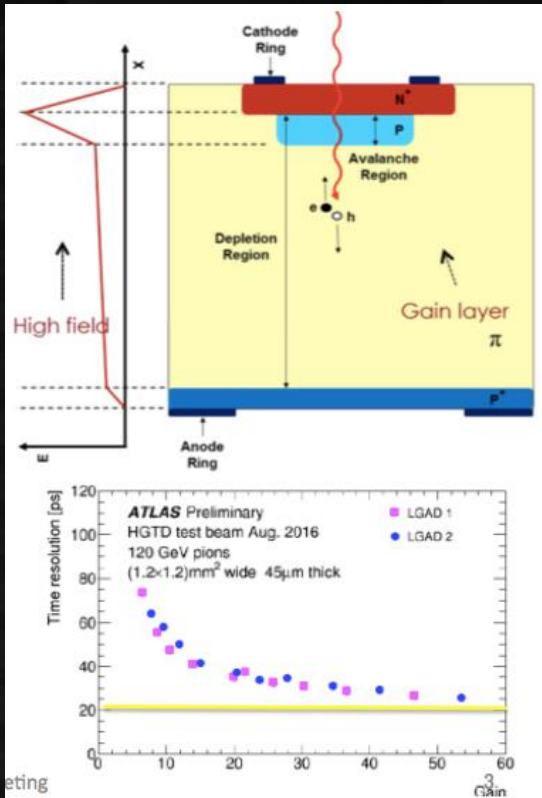
More advanced: 3D to 4D/5D



New dimension of information
→ reveal hidden nature...

Timing resolution

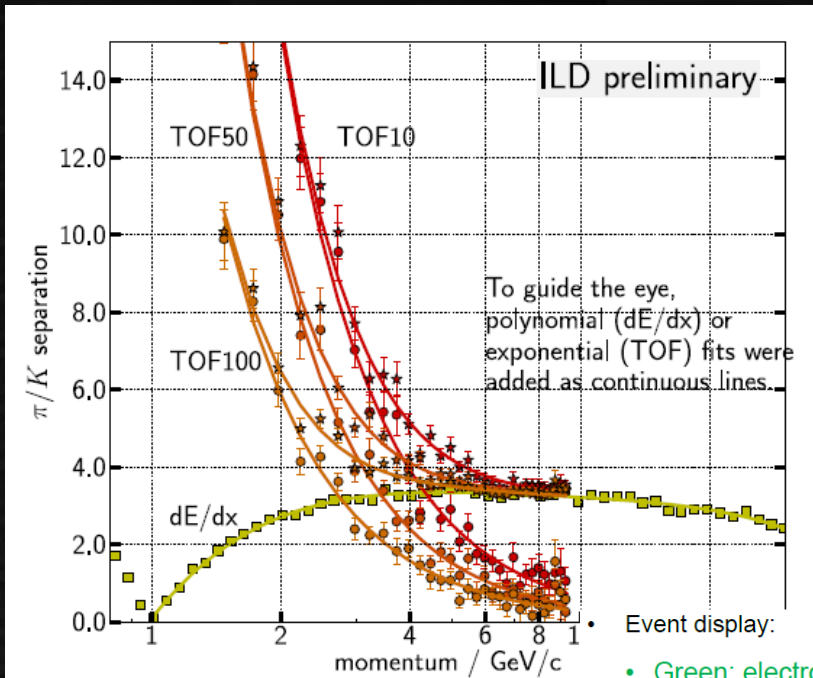
- Vertex: slow (10s of BX)
 - Except chronopix
- Silicon tracker (inner/outer)
 - **Strip, CMOS, HV-CMOS, LGAD**
 - < 1 ns possible with strips
 - Slow for pixels
 - 1 BX tagging possible with intensive effort (if needed)
 - ~20 psec with LGAD
- TPC (slow)
 - Slow if no topological calib.
- Calorimeter (fast)
 - ~100 psec possible with pads
 - ~20 psec with LGAD



Low Gain Avalanche Detector (LGAD) for ultra-fast silicon detector
~20 psec obtained with small sensor
Thin sensor is also possible

Particle ID

- K/π separation by dE/dx and ToF
- dE/dx : a few – a few tens GeV
- ToF: $< 5-10$ GeV
- ToF: outer tracker with 20 psec may improve the potential (LGAD tracker)



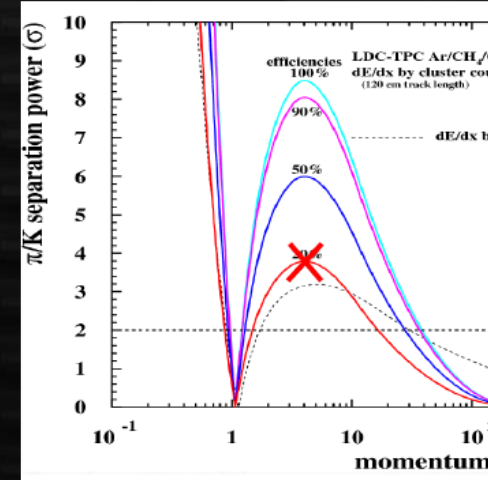
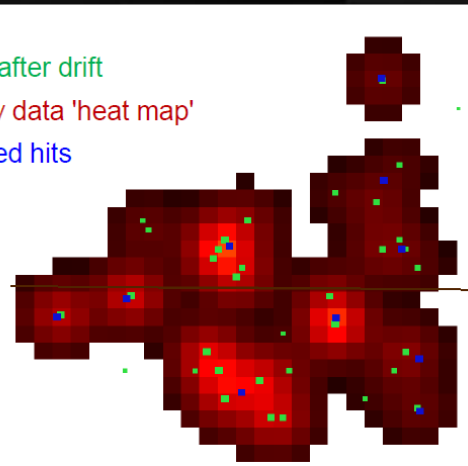
• Event display:

- Green: electrons after drift
- Red: digitised raw data 'heat map'
- Blue: reconstructed hits

• Identify and count clusters / hits



Timepix3 for monolithic TPC readout



Issues on Electronics/Mechanics

- Development of electronics
 - Need silicon circuits (MAPS or ASICs) everywhere
 - Development of MAPS/ASICs needs
 - Time (1-2 year per production needed)
 - Cost (> 200 k\$ initial cost, depending on process & area)
 - Practical large-scale R&D extremely difficult before the project will go
 - Slow progress, more money necessary...
- Replacement/repair
 - ATLAS/CMS needs major upgrade/fix on each LS
 - Is this possible in ILC? How to open calorimeter?

Summary / Way forward

- Considering that the project is not approved yet, we have tremendous progress on detector study
- Base technologies are mature enough for conservative baseline options.
- No fundamental show-stoppers to prevent detectors to make
- Some advanced techniques with timing and PID functions proposed
 - Can consider to use if they become mature enough

Timing resolution

Technology for silicon tracking

Technology	Strip	MAPS	LGAD
Maturity	***	**	*
Position reso	**	**	***
Ghost hits	*	***	*
Speed	**	*	***
Material	*	***	**
Initial cost	****	*	***
Unit cost	**	***?	*

- Compared with the state-of-the-art the proposed solutions can lower the time walk and increase time resolution:
 - Design simple
 - More power consumption
- Other solutions, with higher pixel areas and higher power consumption claim to arrive to 100 ps. In our case we are working with pixels from $50 \times 50 \text{ um}^2$ to $80 \times 80 \text{ um}^2$

Tracker: LGAD possible
ECAL: LGAD is too expensive
Update electronics with
~100 psec possible without
novel sensor technology

